

# ESCC () 4001/023 Qualified High Precision (5 ppm, 0.01 %), Thin Film Chip Resistors



Vishay Sfernice Thin Film division holds ESCC QML qualification (ESCC technology flow qualification).

These High-Rel. components are ideal for low noise and precision applications, superior stability, low temperature coefficient of resistance, and low voltage coefficient, Vishay Sfernice's precision thin film wraparound resistors exceed requirements of MIL-PRF-55342G characteristics Y ( $\pm$  10 ppm/°C).

# FEATURES

- Load life stability at ± 70 °C for 2000 h: 0.15 % under Pn
- Low temperature coefficient down to ± 5 ppm/°C
- Very low noise (< 35 dB) and voltage coefficient (< 0.01 ppm/V)</li>
- Resistance range: 10  $\Omega$  to 3 M $\Omega$  (depending on size)
- Laser trimmed tolerances to  $\pm$  0.01 %
- TCR in lot tracking  $\leq$  5 ppm/°C
- Termination: Thin film technology
- SnPb terminations over nickel barrier
- ESCC 4001 (generic specifications)
- ESCC 4001/023 (detailed specifications)
- ESCC qualified
- SMD wraparound chip resistor
- Operating temperature range: 65 °C to + 155 °C
- From 0402 to 2010
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

STANDARD	STANDARD ELECTRICAL SPECIFICATIONS							
MODEL	SIZE	ESCC VARIANT NUMBER	RESISTANCE RANGE Ω	RATED POWER AT + 70 °C (Pn) W <sup>(1)</sup>	LIMITING ELEMENT VOLTAGE (UL) V <sup>(1)</sup>	INSULATION VOLTAGE ( <i>U</i> i) V	TOLERANCE ± %	TEMPERATURE COEFFICIENT ± ppm/°C
PHR 0402 (2)	0402	13 and 14	10 to 150K	0.05	30	50	0.01, 0.02, 0.05, 0.1	5, 10, 25
PHR 0603 💽	0603	01 and 05	10 to 500K	0.1	35	100	0.01, 0.02, 0.05, 0.1	5, 10, 25
PHR 0805 💽	0805	02 and 06	10 to 750K	0.125	75	200	0.01, 0.02, 0.05, 0.1	5, 10, 25
PHR 1206 💽	1206	03 and 07	10 to 3.5M	0.25	100	300	0.01, 0.02, 0.05, 0.1	5, 10, 25
PHR 2010 💽	2010	04 and 08	10 to 6M	0.50	150	300	0.01, 0.02, 0.05, 0.1	5, 10, 25

#### Notes

<sup>(1)</sup> PHR 0402: Qualification ongoing.

(2) Limiting voltages and power rating are already derated (for maximum ratings admissible, refer to P chip: <u>www.vishay.com/cod?53017</u>).

CLIMATIC SPECIFICATIONS		
Operating temperature range	- 65 °C; + 155 °C	
Soldering temperature (T <sub>sol</sub> )	260 °C, immersion 10 s	

MECHANICAL	SPECIFICATIONS
Substrate material	Alumina
Technology	Thin Film
Film	Nickel Chromium with mineral passivation
Protection	Epoxy and silicone
Terminations	<b>B type:</b> SnPb over nickel barrier for solder reflow <sup>(3)</sup> <b>G type:</b> Gold

#### Note

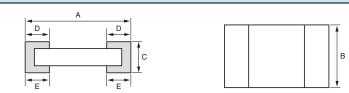
(3) For B terminations use recommended reflow profile #1 as per Application Note "Guidelines for Vishay Sfernice Resistive and Inductive Components" (document number: 52029)

ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com/doc?91000



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#### **DIMENSIONS** in millimeters



			DIMENSIONS							
VARIANT NUMBER STYLE		Α		В		(	С		D/E	
NOMBER		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
01, 05	0603	1.368	1.672	0.723	0.977	0.373	0.627	0.25	0.51	
02, 06	0805	1.758	2.062	1.143	1.397	0.373	0.627	0.25	0.51	
03, 07	1206	2.908	3.212	1.473	1.727	0.373	0.627	0.27	0.53	
04, 08	2010	4.898	5.232	2.413	2.667	0.373	0.627	0.35	0.61	
13, 14	0402	0.848	1.152	0.473	0.727	0.373	0.627	0.15	0.35	

## **NOTION OF SINGLE LOT**

The homogeneity of lots is given by the front end lot numbers (primary process lot) and <u>not</u> by the date code.

The date code is applied after completion of end of production testing. Parts coming from different lots might have same date code. A customer who needs lot homogeneity should mention on his order: SINGLE PRODUCTION LOT

#### **END OF PRODUCTION TESTING**

Mandatory testing performed at the end of the production process:

- 100 % overload: Voltage √(6.25 Pn x Rn) or 2 UL whichever is less duration 2 s
- 100 % burn in: 168 h at Pn at 70 °C

## **OPTIONS**

#### LOT VALIDATION TESTING

For procurement of qualified components, lot validation testing is not required and shall only be performed if specifically stipulated in the purchase order.

For procurement of unqualified components, lot validation testing shall be performed as stipulated in the purchase order. The need for lot validation testing shall be determined by the orderer.

When lot validation testing is required, it shall consist of the performance of one or more of the tests or subgroup test sequences of chart F4 indicated in the ESA Generic Specification ESCC 4001. The testing to be performed and the sample size shall be as stipulated in the purchase order. When procurement of more than one component type is involved from a family, range or series, the selection of representative samples shall also be stipulated in the purchase order.

Lot validation testing will be composed of one LVT charges and LVT samples:

• Lot validation test charges has to be ordered separately on purchase order.

Lot validation samples have to be ordered separately on purchase orderer.

## FINAL INSPECTION

If requested by the orderer a final inspection can be performed on site. Final inspection has to be stipulated separately on purchase order.

LAND PATTERN in millimeters				
G <sub>min.</sub>				
CHIP SIZE	Z <sub>max.</sub>	G <sub>min.</sub>	X <sub>max.</sub>	
0402	1.55	0.15	0.73	
0603	2.37	0.35	0.98	
	2.37	0.35	0.98	
0603 0705/0805 1206				

#### Note

Suggested land pattern: According to IPC-7351A

Revision: 26-Mar-14

Document Number: 53037



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QUALIFIED OHMIC RANGE <sup>(1)</sup>				
MODEL	ESCC VARIANT	OHMIC RANGE (Ω)	TOLERANCE (%)	
		10 to < 50	0.1	
PHR	01 to 08 and 13 to 14 <sup>(2)</sup>	50 to < 100	0.05 and 0.1	
		100 to < 250	0.02, 0.05 and 0.1	
		≥ 250	0.01, 0.02, 0.05 and 0.1	

QUALIFIED OHMIC RANGE <sup>(1)</sup>					
MODEL	ESCC VARIANT	OHMIC RANGE (Ω)	TEMPERATURE COEFFICIENT (ppm/°C)	ESCC CODE	
	01 to 08 and	10 to < 20	E: 25 (- 55 °C; + 155 °C)	2	
PHR			Y: 10 (- 55 °C; + 155 °C)	1	
FUN	13 to 14 <sup>(2)</sup>	20 to < 50	Z: 5 (+ 22 °C; + 70 °C)	0	
		≥ 50	C: 5 (- 55 °C; + 155 °C)	9	

# QUALIFIED OHMIC RANGE: MAX. VALUE <sup>(1)</sup> PHR 0402 <sup>(2)</sup> PHR 0603 PHR 0805 PHR 1206 PHR 2010 100 kΩ (67 kΩ for TCR C) 200 kΩ (160 kΩ for TCR C) 250 kΩ 1 MΩ 3 MΩ

#### Notes

<sup>(1)</sup> For values, TCR, tolerance outside of qualified range: Please consult.

<sup>(2)</sup> PHR 0402: Qualification ongoing.

## **POPULAR OPTIONS**

#### **OPTION 0041**

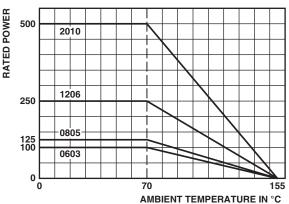
Production according to ESCC 4001/023 for: Cases, ohmic values, tolerance or TCR outside of qualified range. Please consult Vishay Sfernice for feasibility.

PACK	PACKAGING				
Two types of packaging are available: Waffle-pack and tape and reel.					
	NUMBER OF PIECES PER PACKAGE				
SIZE	WAFFLE	TAPE AND REEL <sup>(3)</sup>		TAPE WIDTH	
	PACK 2" × 2"	MIN.	MAX.	WIDTH	
0402			5000		
0603	100		5000		
0805		50	4000	8 mm	
1206	140		4000		
2010	60		2000		

Note

(3) MoQ: 50 pieces

## **POWER DERATING CURVE**



## **EXTENDED FEATURES**

You may consult Vishay Sfernice for chip sizes, ohmic values and tolerances outside of the qualified range.

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PERFORMANCE				
TEST	CONDITIONS	REQUIREMEN	TYPICAL	
1231	CONDITIONS	ESA/SCC 4001/023	MIL-PRF-55342G	TIFICAL
Short time overload	U =√(6.25 Pn x Rn) U <sub>max.</sub> < 2 UL - 2 s	± 0.05 % + (0.05 Ω x 100/Rn)	0.10 %	± 0.01 %
Rapid temperature change	- 55 °C/+ 155 °C 5 cycles CEI 66-2-14 Test Na	± 0.05 % + (0.05 Ω x 100/Rn)	0.1 % (for 100 cycles)	± 0.01 % ± 0.015 % (for 500 cycles)
Soldering (thermal shock)	260 °C/10 s CEI 68-2-20 A Test T6 (met. 1A)	± 0.05 % + (0.05 Ω x 100/Rn)	-	± 0.005 %
Terminal strength: adhesion bend strength of end plated facing	CEI 115-1 Clause 4.32 CEI 115-1 Clause 4.33	± 0.05 % + (0.05 Ω x 100/Rn)	-	± 0.01 %
Climatic sequence	CEI 67-2-1/CEI 68-2-2 CEI 67-2-13/CEI 68-2-30	± 0.10 % + (0.05 Ω x 100/Rn)	-	$\pm$ 0.02 % Insulation resistance > 1 G $\Omega$
Load life	2000 h Pn at + 70 °C 90'/30' cycle	± 0.15 % + (0.05 Ω x 100/Rn)	0.5 %	$\pm$ 0.02 % Insulation resistance > 1 G $\Omega$
High temperature exposure	2000 h Pn at + 155 °C CEI 68-2-20A Test B	± 0.15 % + (0.05 Ω x 100/Rn)	± 0.10 % (duration 1000 h)	$\pm$ 0.05 % Insulation resistance > 1 G $\Omega$

ESCC/PHR CODIFICATION CORRESPONDANCE TABLES				
VARIANT	MODEL	CASE SIZE	TERMINATION	
13		0402		
01		0603		
02		0805	B (tin/lead)	
03	PHR	1206		
04		2010		
14		0402		
05		0603		
06		0805	G (gold)	
07		1206		
08		2010		

ESCC/PHR CODIFICATION CORRESPONDANCE TABLES				
TEMPERATURE COEFFICIENT	ESCC CODE	PHR CODE		
5 ppm/°C (+ 22 °C; + 70 °C)	0	Z		
10 ppm/°C (- 55 °C; + 155 °C)	1	Y		
25 ppm/°C (- 55 °C; + 155 °C)	2	E		
5 ppm/°C (- 55 °C; + 155 °C)	9	C		

ESCC/PHR CODIFICATION CORRESPONDANCE TABLES			
TOLERANCE	ESCC CODE	PHR CODE	
0.1 %	В	В	
0.05 %	W	W	
0.02 %	Р	Р	
0.01 %	L	L	

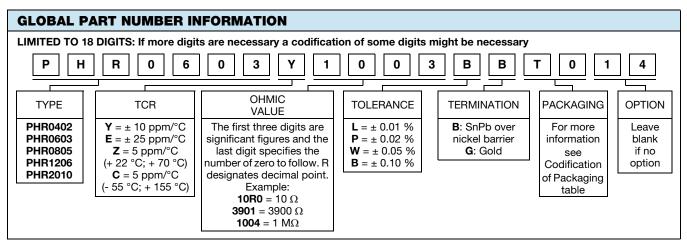
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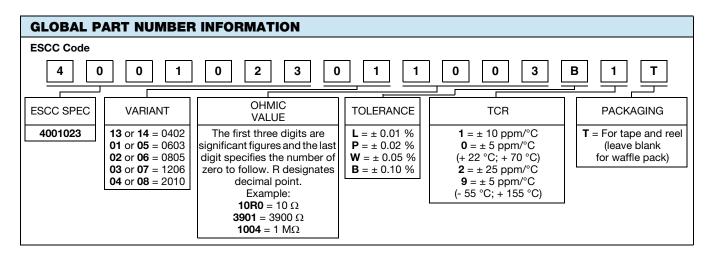
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PHR



#### Note

 Terminations B: Variants 01/03/05/07 and 13 Terminations G: Variants 02/04/06/08 and 14



<b>CODIFICATION PACKAGING</b> - Waffle Pack		
CODE 18	PACKAGING	
W	25 min. (100 min. for size 0402), 1 mult	
WA	100 min., 100 mult <sup>(1)</sup>	

CODIFICATION PACKAGING - Plastic Tape <sup>(2)</sup>	
CODE 18	PACKAGING
Т	50 min. (100 min. for size 0402), 1 mult
TA	100 min., 100 mult
ТВ	250 min., 250 mult
TC	500 min., 500 mult
TD	1000 min., 1000 mult
TE	2500 min., 2500 mult
TF	Full tape <sup>(3)</sup>

CODIFICATION PACKAGING - Paper Tape (2)		
CODE 18	PACKAGING	
PT	100 min., 1 mult	
PA	100 min., 100 mult	
PB	250 min., 250 mult	
PC	500 min., 500 mult	
PD	1000 min., 1000 mult	
PE	2500 min., 2500 mult	
PF	Full tape <sup>(3)</sup>	

#### Notes

<sup>(1)</sup> Available only in size 1206.

(2) Plastic tape in standard for all sizes except 0402. Paper tape in standard for size 0402 (option for other sizes. Availability to be checked with factory).

<sup>(3)</sup> Qty. depending on size of chips.

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